

SN54AS823A, SN74AS823A, SN74AS824A 9-BIT BUS-INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

SDAS231A – JUNE 1984 – REVISED AUGUST 1995

- Functionally Equivalent to AMD's AM29823 and AM29824
- Provide Extra Data Width Necessary for Wider Address/Data Paths or Buses With Parity
- Outputs Have Undershoot-Protection Circuitry
- Power-Up High-Impedance State
- Buffered Control Inputs to Reduce dc Loading Effects
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (NT) and Ceramic (JT) 300-mil DIPs

description

These 9-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. These devices are particularly suitable for implementing wider buffer registers, I/O ports, bidirectional bus drivers, parity bus interfacing, and working registers.

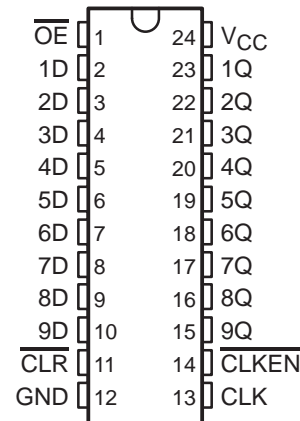
With the clock-enable ($\overline{\text{CLKEN}}$) input low, the nine D-type edge-triggered flip-flops enter data on the low-to-high transitions of the clock (CLK) input. Taking $\overline{\text{CLKEN}}$ high disables the clock buffer, latching the outputs. The SN54AS823A and SN74AS823A have noninverting data (D) inputs and the SN74AS824A has inverting ($\overline{\text{D}}$) inputs. Taking the clear ($\overline{\text{CLR}}$) input low causes the nine Q outputs to go low independently of the clock.

A buffered output-enable ($\overline{\text{OE}}$) input can be used to place the nine outputs in either a normal logic state (high or low logic level) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

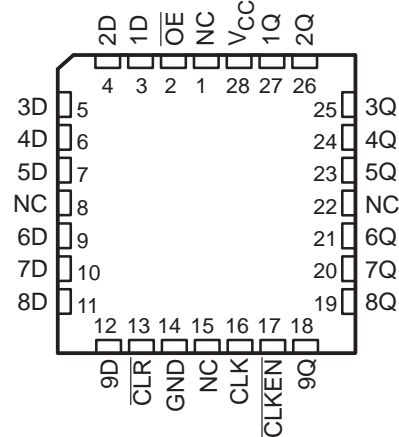
$\overline{\text{OE}}$ does not affect the internal operation of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54AS823A is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AS823A and SN74AS824A are characterized for operation from 0°C to 70°C .

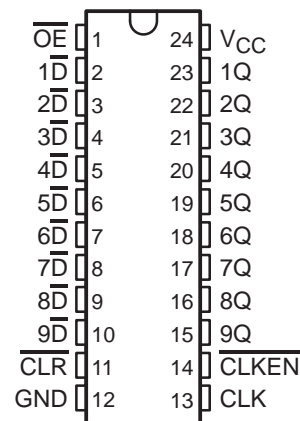
SN54AS823A . . . JT PACKAGE
SN74AS823A . . . DW OR NT PACKAGE
(TOP VIEW)



SN54AS823A . . . FK PACKAGE
(TOP VIEW)



SN74AS824A . . . DW OR NT PACKAGE
(TOP VIEW)



NC – No internal connection

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Function Tables

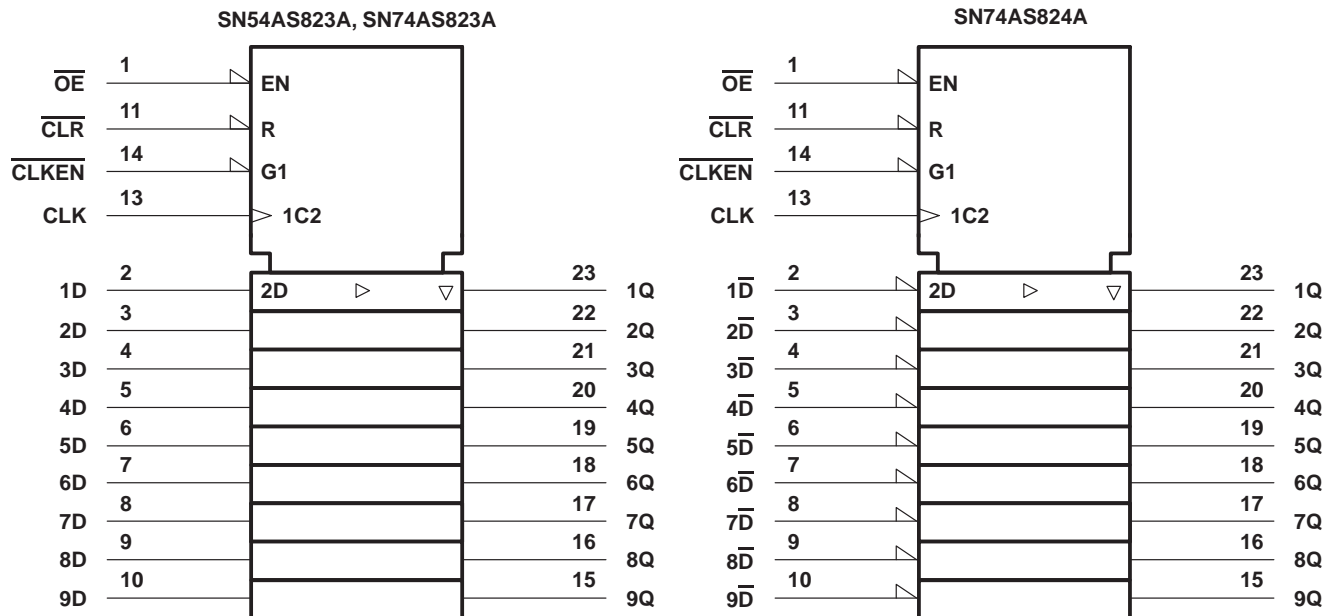
SN54AS823A, SN74AS823A
(each flip-flop)

INPUTS					OUTPUT Q
$\overline{\text{OE}}$	$\overline{\text{CLR}}$	$\overline{\text{CLKEN}}$	CLK	D	
L	L	X	X	X	L
L	H	L	↑	H	H
L	H	L	↑	L	L
L	H	H	X	X	Q_0
H	X	X	X	X	Z

SN74AS824A
(each flip-flop)

INPUTS					OUTPUT Q
$\overline{\text{OE}}$	$\overline{\text{CLR}}$	$\overline{\text{CLKEN}}$	CLK	$\overline{\text{D}}$	
L	L	X	X	X	L
L	H	L	↑	H	L
L	H	L	↑	L	H
L	H	H	X	X	Q_0
H	X	X	X	X	Z

logic symbol†

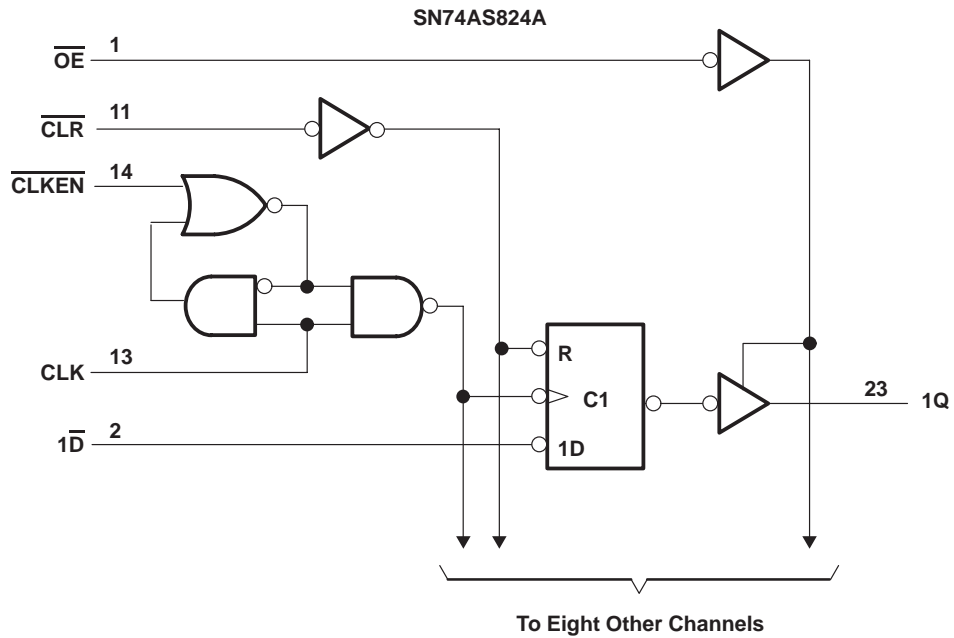
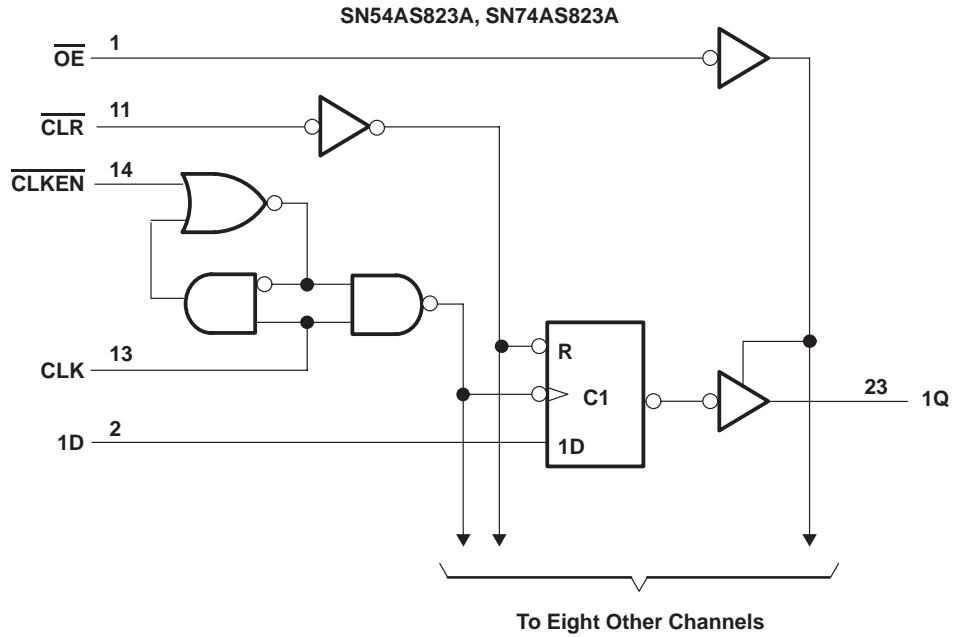


† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DW, JT, and NT packages.

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logic diagrams (positive logic)



Pin numbers shown are for the DW, JT, and NT packages.

SN54AS823A, SN74AS823A, SN74AS824A 9-BIT BUS-INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T_A : SN54AS823A	–55°C to 125°C
SN74AS823A, SN74AS824A	0°C to 70°C
Storage temperature range	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS823A			SN74AS823A SN74AS824A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			–24			–24	mA
I_{OL}	Low-level output current			32			48	mA
t_w^*	Pulse duration	CLR low	7.5		6.5			ns
		CLK high or low	9.5		8			
t_{su}^*	Setup time before CLK↑	CLR high	8		8			ns
		Data	7		6			
		CLKEN high or low	8.5		7.5			
t_h^*	Hold time after CLK↑			0			0	ns
T_A	Operating free-air temperature	–55		125	0		70	°C

* On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

SN54AS823A, SN74AS823A, SN74AS824A 9-BIT BUS-INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54AS823A			SN74AS823A SN74AS824A			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}	$V_{CC} = 4.5\text{ V}$,	$I_I = -18\text{ mA}$			-1.2			-1.2	V
V_{OH}	$V_{CC} = 4.5\text{ V to }5.5\text{ V}$,	$I_{OH} = -2\text{ mA}$	$V_{CC} - 2$			$V_{CC} - 2$			V
	$V_{CC} = 4.5\text{ V}$	$I_{OH} = -15\text{ mA}$	2.4	3.2		2.4	3.2		
		$I_{OH} = -24\text{ mA}$	2			2			
V_{OL}	$V_{CC} = 4.5\text{ V}$	$I_{OL} = 32\text{ mA}$	0.3		0.5			V	
		$I_{OL} = 48\text{ mA}$				0.35	0.5		
I_{OZH}	$V_{CC} = 5.5\text{ V}$,	$V_O = 2.7\text{ V}$				50			μA
I_{OZL}	$V_{CC} = 5.5\text{ V}$,	$V_I = 0.4\text{ V}$				-50			μA
I_I	$V_{CC} = 5.5\text{ V}$,	$V_I = 7\text{ V}$				0.1			mA
I_{IH}	$V_{CC} = 5.5\text{ V}$,	$V_I = 2.7\text{ V}$				20			μA
I_{IL}	$V_{CC} = 5.5\text{ V}$,	$V_I = 0.4\text{ V}$				-0.5			mA
$I_{O\ddagger}$	$V_{CC} = 5.5\text{ V}$,	$V_O = 2.25\text{ V}$	-30		-112	-30		-112	mA
I_{CC}	SN54AS823A, SN74AS823A	$V_{CC} = 5.5\text{ V}$	Outputs high	49	80	49	80	mA	
			Outputs low	61	100	61	100		
			Outputs disabled	64	103	64	103		
	SN74AS824A	$V_{CC} = 5.5\text{ V}$	Outputs high	49	80	49	80		
			Outputs low	61	100	61	100		
			Outputs disabled	64	103	64	103		

† All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .

switching characteristics (see Figure 1)

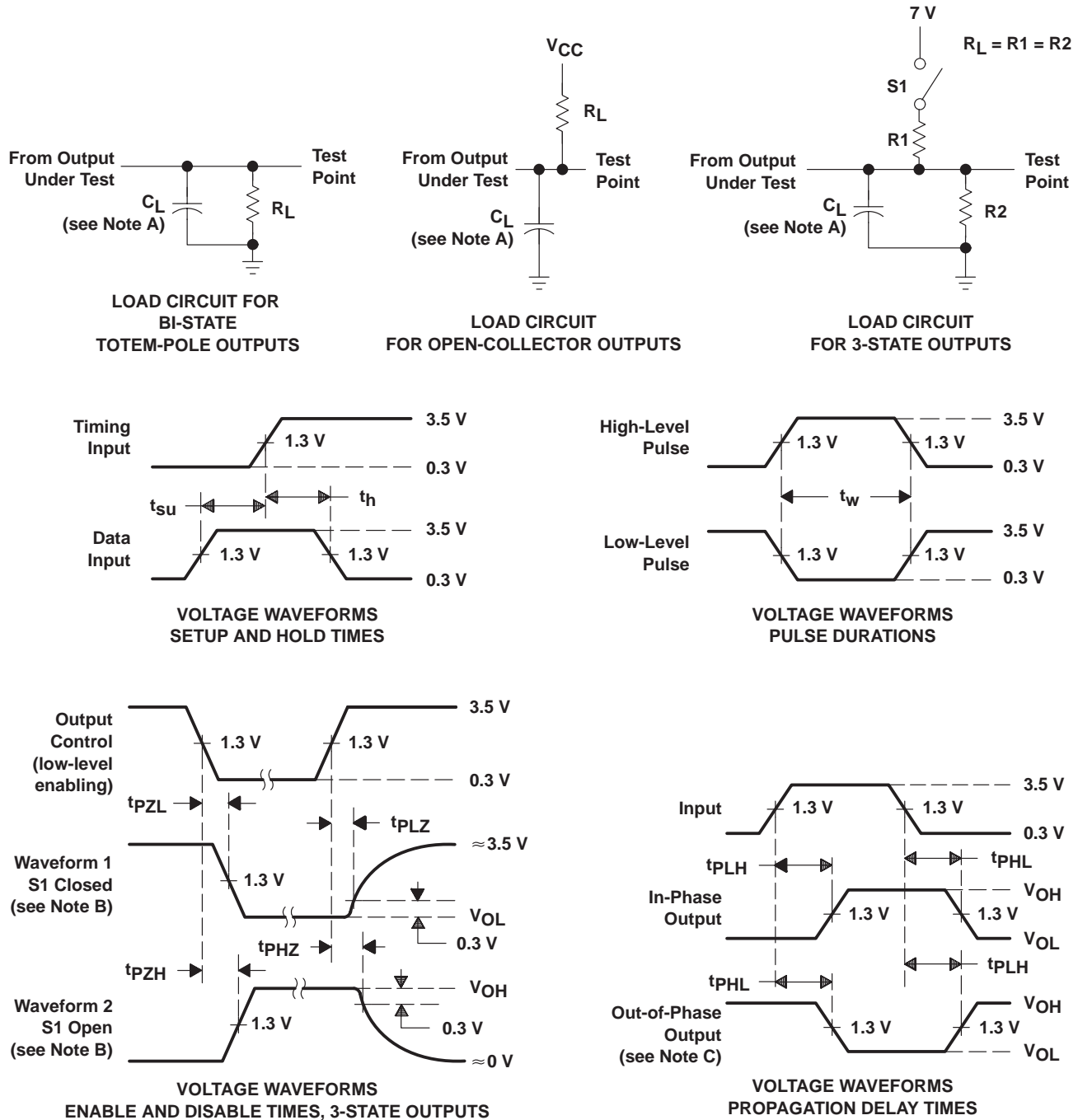
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5\text{ V to }5.5\text{ V}$, $C_L = 50\text{ pF}$, $R_1 = 500\ \Omega$, $R_2 = 500\ \Omega$, $T_A = \text{MIN to MAX}\S$				UNIT
			SN54AS823A		SN74AS823A SN74AS824A		
			MIN	MAX	MIN	MAX	
t_{PLH}	CLK	Any Q	3.5	9	3.5	7.5	ns
t_{PHL}			3.5	14	3.5	13	
t_{PHL}	$\overline{\text{CLR}}$	Any Q	3.5	16.5	3.5	15.5	ns
t_{PZH}	$\overline{\text{OE}}$	Any Q	4	12	4	11	ns
t_{PZL}			4	13	4	12	
t_{PHZ}	$\overline{\text{OE}}$	Any Q	1	10	1	8	ns
t_{PLZ}			1	10	1.5	8	

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
 E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-8952501LA	ACTIVE	CDIP	JT	24	15	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8952501LA SNJ54AS823AJT	
SNJ54AS823AJT	ACTIVE	CDIP	JT	24	15	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8952501LA SNJ54AS823AJT	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

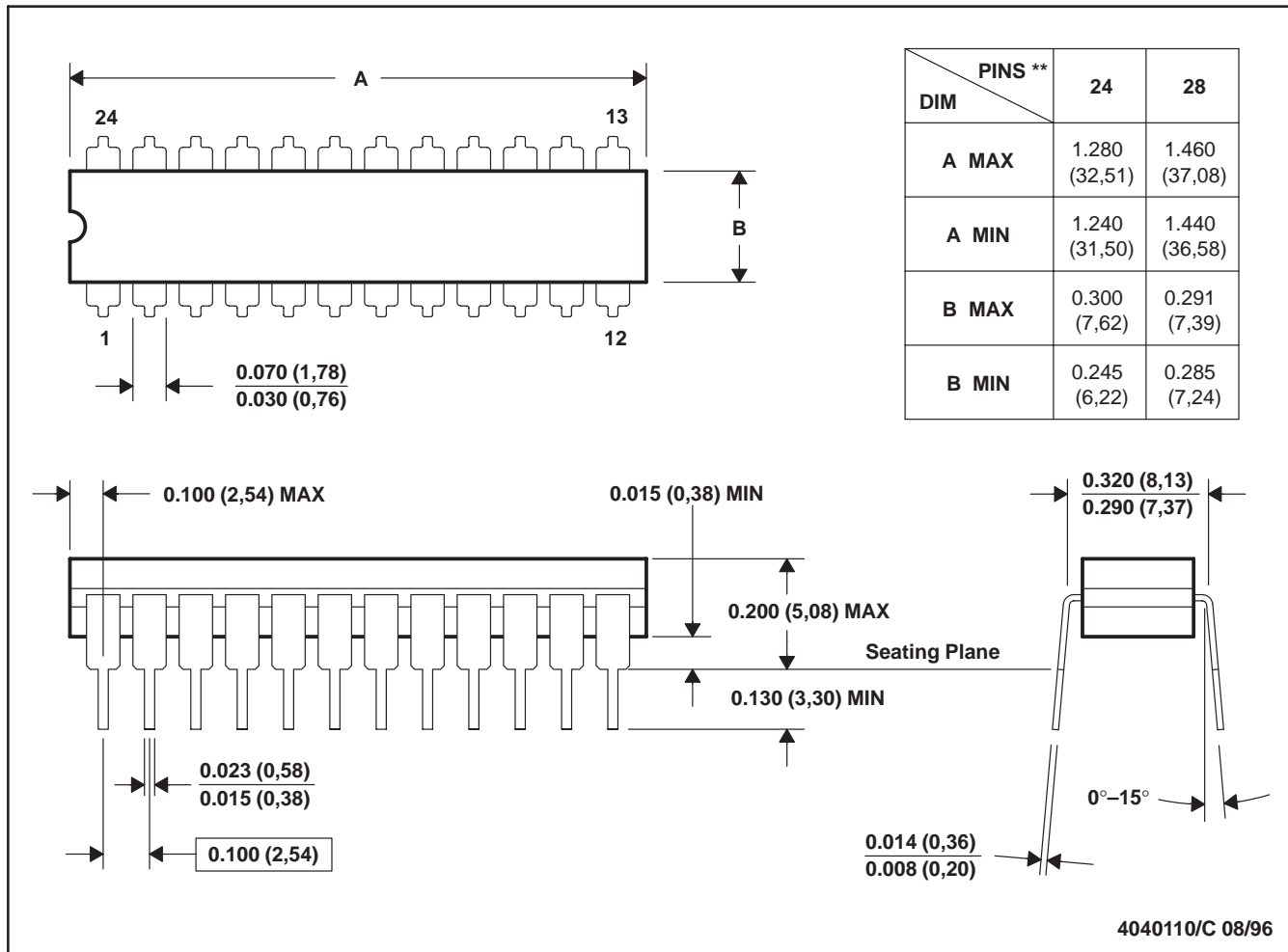
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JT (R-GDIP-T**)

CERAMIC DUAL-IN-LINE

24 LEADS SHOWN



4040110/C 08/96

- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a ceramic lid using glass frit.
 D. Index point is provided on cap for terminal identification.
 E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

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